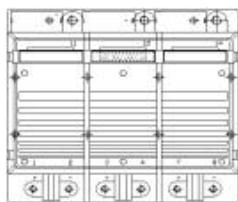


Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$ unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1200	V
$V_{CC}^1)$	Operating DC link voltage	900	V
V_{GES}		± 20	V
I_C	$T_s = 25 \text{ (70)}^\circ\text{C}$	150 (112)	A
Inverse diode			
$I_F = -I_C$	$T_s = 25 \text{ (70)}^\circ\text{C}$	150 (112)	A
I_{FSM}	$T_j = 150^\circ\text{C}$, $t_p = 10 \text{ ms}$; sin.	1440	A
I^2t (Diode)	Diode, $T_j = 150^\circ\text{C}$, 10 ms	10	kA ² s
T_j (T_{stg})		- 40 (- 25) ... + 150 (125)	°C
V_{isol}	AC, 1 min. (mainterminals to heat sink)	3000	V



SKiiP® 2

6-pack - integrated intelligent Power System

Power section

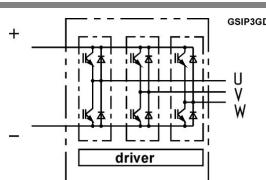
SKiiP 132GD120-3DU

Power section features

- SKiiP technology inside
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP® 2 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532

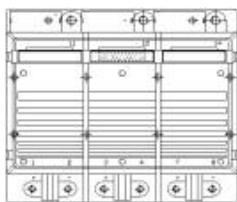
¹⁾ with assembly of suitable MKP capacitor per terminal

Characteristics		$T_s = 25^\circ\text{C}$ unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
IGBT				
V_{CEsat}	$I_C = 125 \text{ A}$, $T_j = 25 \text{ (125)}^\circ\text{C}$	2,6 (3,1)	3,1	V
V_{CEO}	$T_j = 25 \text{ (125)}^\circ\text{C}$	1,2 (1,3)	1,5 (1,6)	V
r_{CE}	$T_j = 25 \text{ (125)}^\circ\text{C}$	10,5 (14)	12,6 (16,1)	mΩ
I_{CES}	$V_{GE} = 0 \text{ V}$, $V_{CE} = V_{CES}$, $T_j = 25 \text{ (125)}^\circ\text{C}$	(10)	0,4	mA
$E_{on} + E_{off}$	$I_C = 125 \text{ A}$, $V_{CC} = 600 \text{ V}$ $T_j = 125^\circ\text{C}$, $V_{CC} = 900 \text{ V}$	38	mJ	
		66	mJ	
$R_{CC' + EE'}$	terminal chip, $T_j = 125^\circ\text{C}$	0,5		mΩ
L_{CE}	top, bottom	15		nH
C_{CHC}	per phase, AC-side	1,4		nF
Inverse diode				
$V_F = V_{EC}$	$I_F = 150 \text{ A}$, $T_j = 25 \text{ (125)}^\circ\text{C}$	2,1 (1,9)	2,6	V
V_{TO}	$T_j = 25 \text{ (125)}^\circ\text{C}$	1,3 (1)	1,4 (1,1)	V
r_T	$T_j = 25 \text{ (125)}^\circ\text{C}$	5 (6)	6,8 (7,8)	mΩ
E_{rr}	$I_C = 125 \text{ A}$, $V_{CC} = 600 \text{ V}$ $T_j = 125^\circ\text{C}$, $V_{CC} = 900 \text{ V}$	6	mJ	
		8	mJ	
Mechanical data				
M_{dc}	DC terminals, SI Units	6	8	Nm
M_{ac}	AC terminals, SI Units	13	15	Nm
w	SKiiP® 2 System w/o heat sink	2,7		kg
w	heat sink	6,6		kg
Thermal characteristics (P16 heat sink; 295 m³/h); " r " reference to temperature sensor				
$R_{th(j-s)I}$	per IGBT		0,18	K/W
$R_{th(j-s)D}$	per diode		0,375	K/W
$R_{th(s-a)}$	per module		0,036	K/W
Z_{th}	R_i (mK/W) (max. values)		tau _i (s)	
	1 2 3 4	1 2 3 4		
$Z_{th(j-r)I}$	20 139 22 0	1 0,13 0,001		1
$Z_{th(j-r)D}$	41 289 45 0	1 0,13 0,001		1
$Z_{th(r-a)}$	11,1 18,3 3,5 3,1	204 60 6		0,02



Case S 3

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SKiiP® 2

6-pack - integrated intelligent Power System

6-pack integrated gate driver

SKiiP 132GD120-3DU

Gate driver features

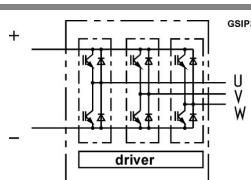
- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 25/85/56

Absolute Maximum Ratings		$T_a = 25^\circ\text{C}$ unless otherwise specified		
Symbol	Conditions	Values		Units
V_{S1}	stabilized 15 V power supply	18		V
V_{S2}	unstabilized 24 V power supply	30		V
V_{iH}	input signal voltage (high)	15 + 0,3		V
$\frac{dv}{dt}$	secondary to primary side	75		$\text{kV}/\mu\text{s}$
V_{isolIO}	input / output (AC, r.m.s., 2s)	3000		Vac
V_{isol12}	output 1 / output 2 (AC, r.m.s., 2s)	1500		Vac
f_{sw}	switching frequency	20		kHz
f_{out}	output frequency for $I=I_C \sin.$	1		kHz
$T_{op} (T_{stg})$	operating / storage temperature	- 40 ... + 85		°C

Characteristics $(T_a = 25^\circ\text{C})$				
Symbol	Conditions	min.	typ.	max.
V_{S1}	supply voltage stabilized	14,4	15	15,6
V_{S2}	supply voltage non stabilized	20	24	30
I_{S1}	$V_{S1} = 15 \text{ V}$	$410+280*f/f_{\text{max}}+3,6*(I_{AC}/A)$		
I_{S2}	$V_{S2} = 24 \text{ V}$	$300+200*f/f_{\text{max}}+2,6*(I_{AC}/A)$		
V_{IT+}	input threshold voltage (High)	12,3		
V_{IT-}	input threshold voltage (Low)	4,6		
R_{IN}	input resistance	10		
$t_{d(on)}IO$	input-output turn-on propagation time	1,5		
$t_{d(off)}IO$	input-output turn-off propagation time	1,4		
$t_{pERRRESET}$	error memory reset time	9		
t_{TD}	top / bottom switch : interlock time	2,3		
$I_{analogOUT}$	8 V corresponds to max. current of 15 V supply voltage (available when supplied with 24 V)	150		
$I_{Vs1outmax}$	output current at pin 13/20/22/24/26	50		
I_{A0max}	logic low output voltage	5		
V_{O1}	logic high output voltage	0,6		
V_{OH}		30		
I_{TRIPSC}	over current trip level ($I_{analog OUT} = 10 \text{ V}$)	188		
I_{TRIPLG}	ground fault protection	43		
T_{tp}	over temperature protection	110		
U_{DCTRIP}	trip level of U_{DC} -protection ($U_{analog OUT} = 9 \text{ V}$); (option)	900		
		120		
		V		

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Case S 3